

RoHS Compliant Product  
A suffix of "-C" specifies halogen & lead-free

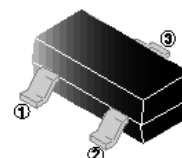
## FEATURES

- Trench Power LV MOSFET Technology
- High Power and Current Handling Capability

**SOT-523**

## APPLICATION

- PWM Application
- Load Switch



## MARKING

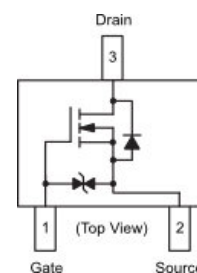
34A

## PACKAGE INFORMATION

Package	MPQ	Leader Size
SOT-523	3K	7 inch

## ORDER INFORMATION

Part Number	Type
SCG05K20-C	Lead (Pb)-free and Halogen-free



## ABSOLUTE MAXIMUM RATINGS ( $T_A=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Drain Current @Steady State	$I_D$	$T_A=25^\circ\text{C}$	0.5
		$T_A=70^\circ\text{C}$	0.4
Pulsed Drain Current <sup>1</sup>	$I_{DM}$	3.3	A
Total Power Dissipation	$P_D$	0.18	W
Thermal Resistance from Junction-Ambient @Steady State	$R_{\theta JA}$	694	$^\circ\text{C/W}$
Operating Junction & Storage Temperature Range	$T_J, T_{STG}$	-55~150	$^\circ\text{C}$

**ELECTRICAL CHARACTERISTICS** (T<sub>J</sub>=25°C unless otherwise specified)

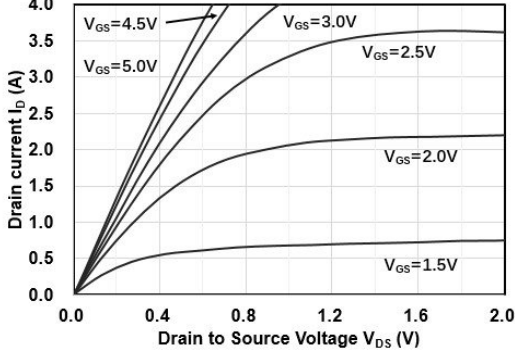
Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	20	-	-	V	V <sub>GS</sub> =0, I <sub>D</sub> =250μA
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.35	0.75	1.1	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA
Gate-Body Leakage Current	I <sub>GSS</sub>	-	0.5	±2	μA	V <sub>GS</sub> = ±8V, V <sub>DS</sub> =0
		-	2	±10		V <sub>GS</sub> = ±10V, V <sub>DS</sub> =0
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	-	-	1	μA	V <sub>DS</sub> =20V, V <sub>GS</sub> =0
Drain-Source On-Resistance	R <sub>DS(ON)</sub>	-	220	300	mΩ	V <sub>GS</sub> =4.5V, I <sub>D</sub> =0.5A
		-	290	400		V <sub>GS</sub> =2.5V, I <sub>D</sub> =0.4A
		-	420	700		V <sub>GS</sub> =1.8V, I <sub>D</sub> =0.2A
Gate resistance	R <sub>G</sub>	-	50	-	Ω	f=1MHz, Open drain
Total Gate Charge	Q <sub>g</sub>	-	1	-	nC	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =10V, I <sub>D</sub> =0.5A
Gate-Source Charge	Q <sub>gs</sub>	-	0.28	-		
Gate-Drain Charge	Q <sub>gd</sub>	-	0.22	-		
Turn-on Delay Time	t <sub>(on)</sub>	-	2	-	nS	V <sub>GS</sub> =4.5V, V <sub>DD</sub> =10V, I <sub>D</sub> =0.5A, R <sub>G</sub> =10Ω
Rise Time	t <sub>r</sub>	-	18.8	-		
Turn-off Delay Time	t <sub>(off)</sub>	-	10	-		
Fall Time	t <sub>f</sub>	-	23	-		
Input Capacitance	C <sub>iss</sub>	-	56	-	pF	V <sub>DS</sub> =10V V <sub>GS</sub> =0 f=1MHz
Output Capacitance	C <sub>oss</sub>	-	20	-		
Reverse Transfer Capacitance	C <sub>rss</sub>	-	2.5	-		
<b>Source-Drain Diode</b>						
Diode Forward Voltage <sup>2</sup>	V <sub>SD</sub>	-	-	1.2	V	V <sub>GS</sub> =0, I <sub>S</sub> =0.5A
Maximum Body-Diode Continuous Current	I <sub>S</sub>	-	-	0.5	A	
Reverse Recovery Time	T <sub>rr</sub>	-	14.4	-	nS	I <sub>F</sub> =0.5A
Recovered Charge	Q <sub>r</sub>	-	0.4	-	nC	di/dt=20A/μs

Notes:

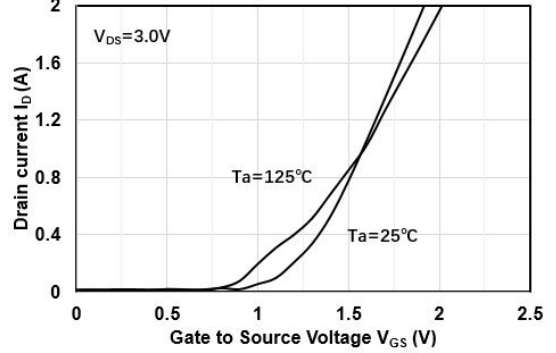
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Pulse Test: Pulse Width≤300us, Duty Cycle≤0.5%.

**TYPICAL CHARACTERISTICS**

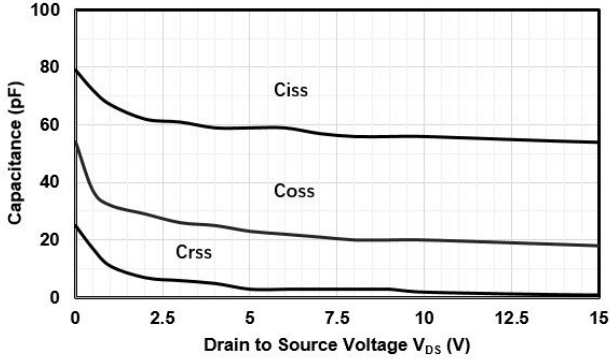
**Figure 1. Output Characteristics**



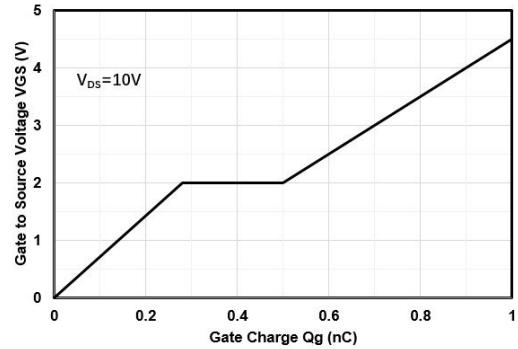
**Figure 2. Transfer Characteristics**



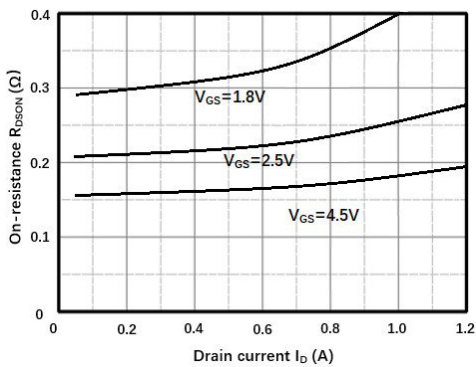
**Figure 3. Capacitance Characteristics**



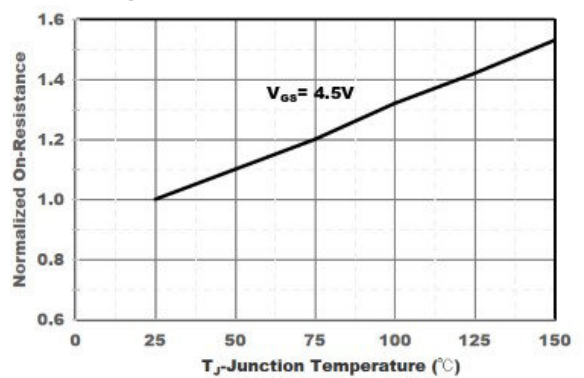
**Figure 4. Gate Charge**



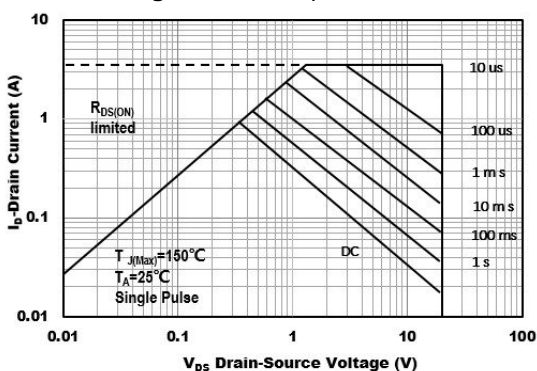
**Figure 5. Drain-Source on Resistance**



**Figure 6. Drain-Source on Resistance**



**Figure 7. Safe Operation Area**



**Figure 8. Switching wave**

